MC10111

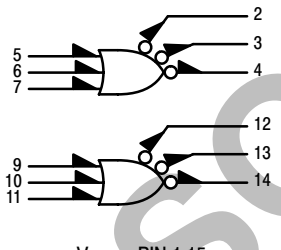
Dual 3-Input/3-Ouput NOR Gate

The MC10111 is designed to drive up to three transmission lines simul− taneously. The multiple outputs of this device also allow the wire "OR"−ing of several levels of gating for minimization of gate and package count.

The ability to control three parallel lines from a single point makes the MC10111 particularly useful in clock distribution applications where minimum clock skew is desired. Three V_{CC} pins are provided and each one should be used.

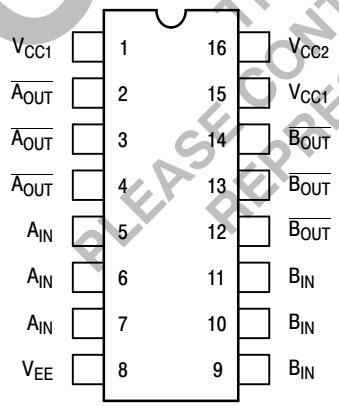
- P_D = 80 mW typ/gate (No Load)
- t_{pd} = 2.4 ns typ (All Outputs Loaded)
- t_r, t_f = 2.2 ns typ (20%−80%)

LOGIC DIAGRAM



V_{CC1} = PIN 1,15
V_{CC2} = PIN 16
V_{EE} = PIN 8

DIP PIN ASSIGNMENT

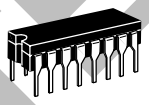


Pin assignment is for Dual−in−Line Package.
For PLCC pin assignment, see the Pin Conversion Tables on page 18 of the ON Semiconductor MECL Data Book (DL122/D).

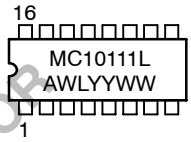
ON Semiconductor

http://onsemi.com

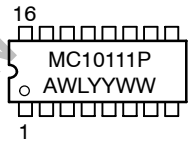
MARKING DIAGRAMS



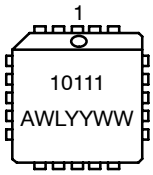
CDIP−16
L SUFFIX
CASE 620



PDIP−16
P SUFFIX
CASE 648



PLCC−20
FN SUFFIX
CASE 775



A = Assembly Location
WL = Wafer Lot
YY = Year
WW = Work Week

ORDERING INFORMATION

Device	Package	Shipping
MC10111L	CDIP−16	25 Units / Rail
MC10111P	PDIP−16	25 Units / Rail
MC10111FN	PLCC−20	46 Units / Rail

ELECTRICAL CHARACTERISTICS

Characteristic	Symbol	Pin Under Test	Test Limits							Unit
			−30°C		+25°C			+85°C		
			Min	Max	Min	Typ	Max	Min	Max	
Power Supply Drain Current	I_E	8		42		30	38		42	mAdc
Input Current	I_{inH}	5, 6, 7		680			425		425	μAdc
	I_{inL}	5, 6, 7	0.5		0.5			0.3		μAdc
Output Voltage Logic 1	V_{OH}	2	−1.060	−0.890	−0.960		−0.810	−0.890	−0.700	Vdc
		3	−1.060	−0.890	−0.960		−0.810	−0.890	−0.700	
		4	−1.060	−0.890	−0.960		−0.810	−0.890	−0.700	
Output Voltage Logic 0	V_{OL}	2	−1.890	−1.675	−1.850		−1.650	−1.825	−1.615	Vdc
		3	−1.890	−1.675	−1.850		−1.650	−1.825	−1.615	
		4	−1.890	−1.675	−1.850		−1.650	−1.825	−1.615	
Threshold Voltage Logic 1	V_{OHA}	2	−1.080		−0.980			−0.910		Vdc
		3	−1.080		−0.980			−0.910		
		4	−1.080		−0.980			−0.910		
Threshold Voltage Logic 0	V_{OLA}	2		−1.655			−1.630		−1.595	Vdc
		3		−1.655			−1.630		−1.595	
		4		−1.655			−1.630		−1.595	
Switching Times (50Ω Load)										ns
Propagation Delay	t_{5+2-}	2	1.4	3.5	1.4	2.4	3.5	1.5	3.8	
	t_{5-2+}	2	1.4	3.5	1.4	2.4	3.5	1.5	3.8	
	t_{5+3-}	3	1.4	3.5	1.4	2.4	3.5	1.5	3.8	
	t_{5-3+}	3	1.4	3.5	1.4	2.4	3.5	1.5	3.8	
	t_{5+4-}	4	1.4	3.5	1.4	2.4	3.5	1.5	3.8	
	t_{5-4+}	4	1.4	3.5	1.4	2.4	3.5	1.5	3.8	
Rise Time (20 to 80%)	t_{2+}	2	1.0	3.5	1.1	2.2	3.5	1.2	3.8	
	t_{3+}	3	1.0	3.5	1.1	2.2	3.5	1.2	3.8	
	t_{4+}	4	1.0	3.5	1.1	2.2	3.5	1.2	3.8	
Fall Time (20 to 80%)	t_{2-}	2	1.0	3.5	1.1	2.2	3.5	1.2	3.8	
	t_{3-}	3	1.0	3.5	1.1	2.2	3.5	1.2	3.8	
	t_{4-}	4	1.0	3.5	1.1	2.2	3.5	1.2	3.8	

ELECTRICAL CHARACTERISTICS (continued)

@ Test Temperature	V_{IHmax}	V_{ILmin}	V_{IHAmin}	V_{ILAmax}	V_{EE}
–30°C	–0.890	–1.890	–1.205	–1.500	–5.2
+25°C	–0.810	–1.850	–1.105	–1.475	–5.2
+85°C	–0.700	–1.825	–1.035	–1.440	–5.2

TEST VOLTAGE VALUES (Volts)

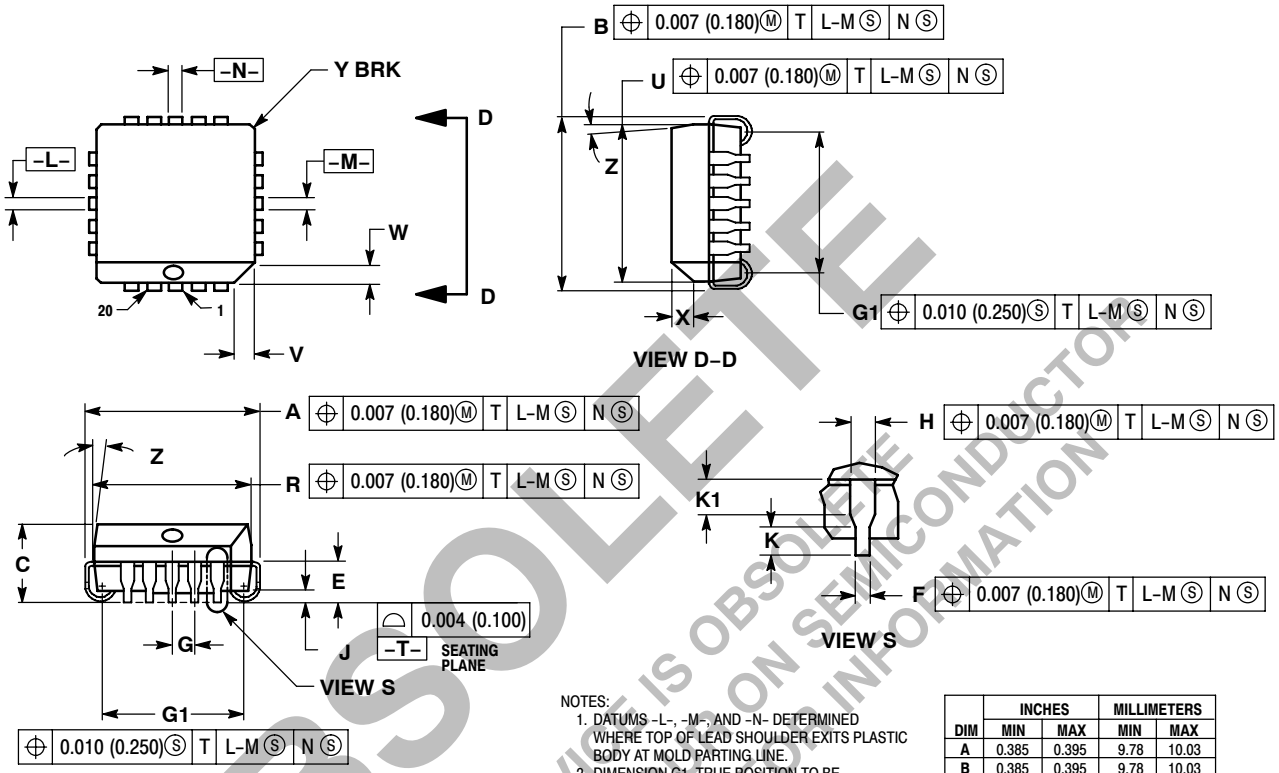
Characteristic		Symbol	Pin Under Test	TEST VOLTAGE APPLIED TO PINS LISTED BELOW					(V_{CC}) Gnd
				V_{IHmax}	V_{ILmin}	V_{IHAmin}	V_{ILAmax}	V_{EE}	
Power Supply Drain Current		I_E	8					8	1, 15, 16
Input Current		I_{inH}	5, 6, 7	*				8	1, 15, 16
		I_{inL}	5, 6, 7		*			8	1, 15, 16
Output Voltage	Logic 1	V_{OH}	2					8	1, 15, 16
			3					8	1, 15, 16
			4					8	1, 15, 16
Output Voltage	Logic 0	V_{OL}	2	5				8	1, 15, 16
			3	6				8	1, 15, 16
			4	7				8	1, 15, 16
Threshold Voltage	Logic 1	V_{OHA}	2				5	8	1, 15, 16
			3				6	8	1, 15, 16
			4				7	8	1, 15, 16
Threshold Voltage	Logic 0	V_{OLA}	2			5		8	1, 15, 16
			3			6		8	1, 15, 16
			4			7		8	1, 15, 16
Switching Times	(50Ω Load)					**Pulse In**	**Pulse Out**	**–3.2 V**	**+2.0 V**
Propagation Delay		t_{5+2-}	2			5	2	8	1, 15, 16
		t_{5-2+}	2			5	2	8	1, 15, 16
		t_{5+3-}	3			5	3	8	1, 15, 16
		t_{5-3+}	3			5	3	8	1, 15, 16
		t_{5+4-}	4			5	4	8	1, 15, 16
		t_{5-4+}	4			5	4	8	1, 15, 16
Rise Time	(20 to 80%)	t_{2+}	2			5	2	8	1, 15, 16
		t_{3+}	3			5	3	8	1, 15, 16
		t_{4+}	4			5	4	8	1, 15, 16
Fall Time	(20 to 80%)	t_{2-}	2			5	2	8	1, 15, 16
		t_{3-}	3			5	3	8	1, 15, 16
		t_{4-}	4			5	4	8	1, 15, 16

* Individually test each input using the pin connections shown.

Each MECL 10,000 series circuit has been designed to meet the dc specifications shown in the test table, after thermal equilibrium has been established. The circuit is in a test socket or mounted on a printed circuit board and transverse air flow greater than 500 linear fpm is maintained. Outputs are terminated through a 50-ohm resistor to –2.0 volts. Test procedures are shown for only one gate. The other gates are tested in the same manner.

PACKAGE DIMENSIONS

PLCC–20
FN SUFFIX
PLASTIC PLCC PACKAGE
CASE 775–02
ISSUE C

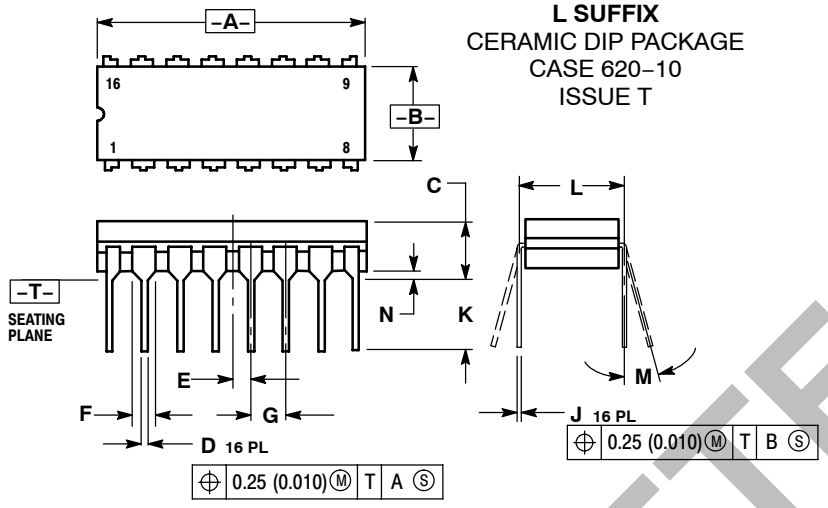


NOTES:
1. DATUMS –L–, –M–, AND –N– DETERMINED WHERE TOP OF LEAD SHOULDER EXITS PLASTIC BODY AT MOLD PARTING LINE.
2. DIMENSION G1, TRUE POSITION TO BE MEASURED AT DATUM –T–, SEATING PLANE.
3. DIMENSIONS R AND U DO NOT INCLUDE MOLD FLASH. ALLOWABLE MOLD FLASH IS 0.010 (0.250) PER SIDE.
4. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
5. CONTROLLING DIMENSION: INCH.
6. THE PACKAGE TOP MAY BE SMALLER THAN THE PACKAGE BOTTOM BY UP TO 0.012 (0.300). DIMENSIONS R AND U ARE DETERMINED AT THE OUTERMOST EXTREMES OF THE PLASTIC BODY EXCLUSIVE OF MOLD FLASH, TIE BAR BURRS, GATE BURRS AND INTERLEAD FLASH, BUT INCLUDING ANY MISMATCH BETWEEN THE TOP AND BOTTOM OF THE PLASTIC BODY.
7. DIMENSION H DOES NOT INCLUDE DAMBAR PROTRUSION OR INTRUSION. THE DAMBAR PROTRUSION(S) SHALL NOT CAUSE THE H DIMENSION TO BE GREATER THAN 0.037 (0.940). THE DAMBAR INTRUSION(S) SHALL NOT CAUSE THE H DIMENSION TO BE SMALLER THAN 0.025 (0.635).

	INCHES		MILLIMETERS	
DIM	MIN	MAX	MIN	MAX
A	0.385	0.395	9.78	10.03
B	0.385	0.395	9.78	10.03
C	0.165	0.180	4.20	4.57
E	0.090	0.110	2.29	2.79
F	0.013	0.019	0.33	0.48
G	0.050 BSC		1.27 BSC	
H	0.026	0.032	0.66	0.81
J	0.020	---	0.51	---
K	0.025	---	0.64	---
R	0.350	0.356	8.89	9.04
U	0.350	0.356	8.89	9.04
V	0.042	0.048	1.07	1.21
W	0.042	0.048	1.07	1.21
X	0.042	0.056	1.07	1.42
Y	---	0.020	---	0.50
Z	2°	10°	2°	10°
G1	0.310	0.330	7.88	8.38
K1	0.040	---	1.02	---

PACKAGE DIMENSIONS

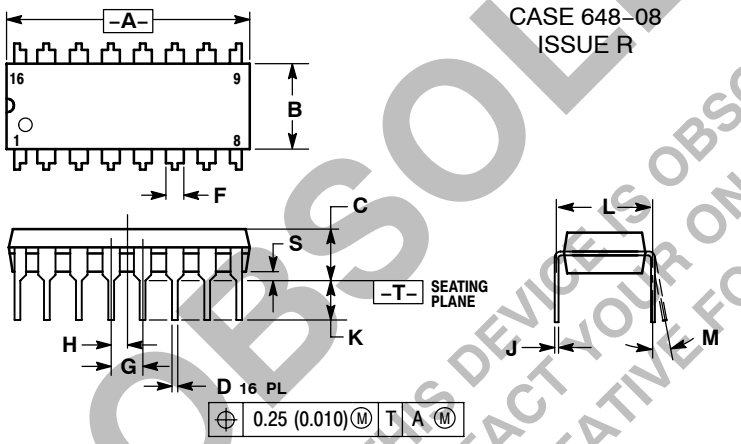
CDIP–16
L SUFFIX
CERAMIC DIP PACKAGE
CASE 620–10
ISSUE T



NOTES:
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: INCH.
3. DIMENSION L TO CENTER OF LEAD WHEN FORMED PARALLEL.
4. DIMENSION F MAY NARROW TO 0.76 (0.030) WHERE THE LEAD ENTERS THE CERAMIC BODY.

	INCHES		MILLIMETERS	
DIM	MIN	MAX	MIN	MAX
A	0.750	0.785	19.05	19.93
B	0.240	0.295	6.10	7.49
C	---	0.200	---	5.08
D	0.015	0.020	0.39	0.50
E	0.050 BSC		1.27 BSC	
F	0.055	0.065	1.40	1.65
G	0.100 BSC		2.54 BSC	
H	0.008	0.015	0.21	0.38
K	0.125	0.170	3.18	4.31
L	0.300 BSC		7.62 BSC	
M	0 °	15 °	0 °	15 °
N	0.020	0.040	0.51	1.01

PDIP–16
P SUFFIX
PLASTIC DIP PACKAGE
CASE 648–08
ISSUE R



NOTES:
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: INCH.
3. DIMENSION L TO CENTER OF LEADS WHEN FORMED PARALLEL.
4. DIMENSION B DOES NOT INCLUDE MOLD FLASH.
5. ROUNDED CORNERS OPTIONAL.

	INCHES		MILLIMETERS	
DIM	MIN	MAX	MIN	MAX
A	0.740	0.770	18.80	19.55
B	0.250	0.270	6.35	6.85
C	0.145	0.175	3.69	4.44
D	0.015	0.021	0.39	0.53
F	0.040	0.70	1.02	1.77
G	0.100 BSC		2.54 BSC	
H	0.050 BSC		1.27 BSC	
J	0.008	0.015	0.21	0.38
K	0.110	0.130	2.80	3.30
L	0.295	0.305	7.50	7.74
M	0 °	10 °	0 °	10 °
S	0.020	0.040	0.51	1.01

PUBLICATION ORDERING INFORMATION

LITERATURE FULFILLMENT:
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